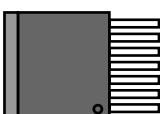
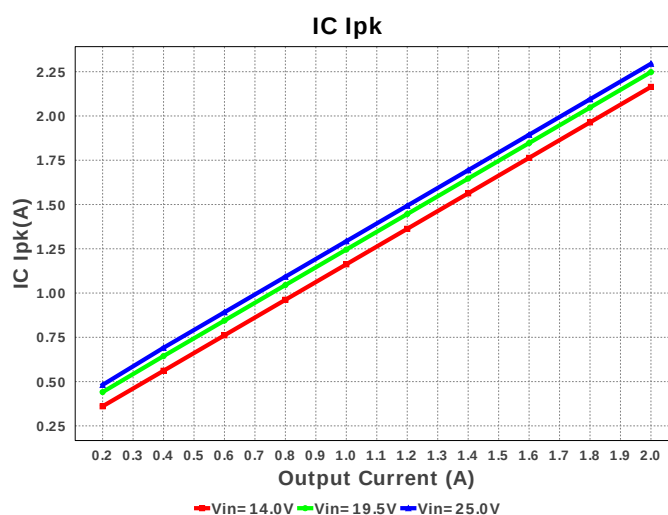
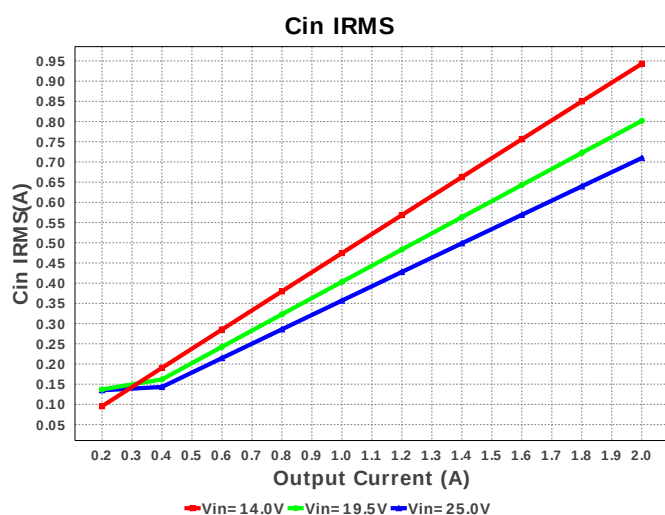
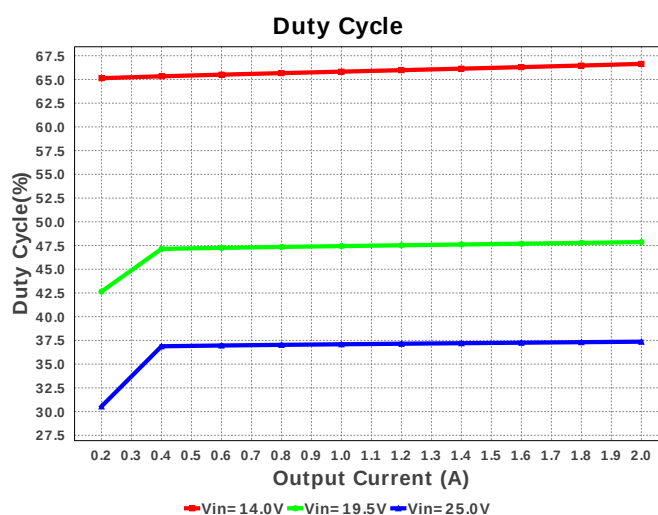
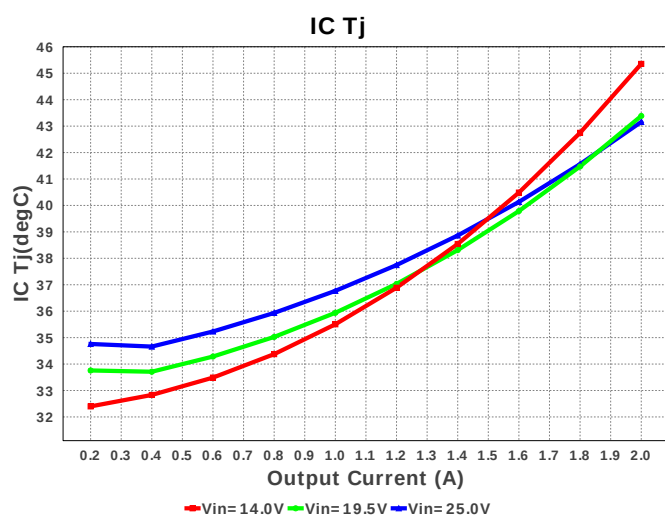
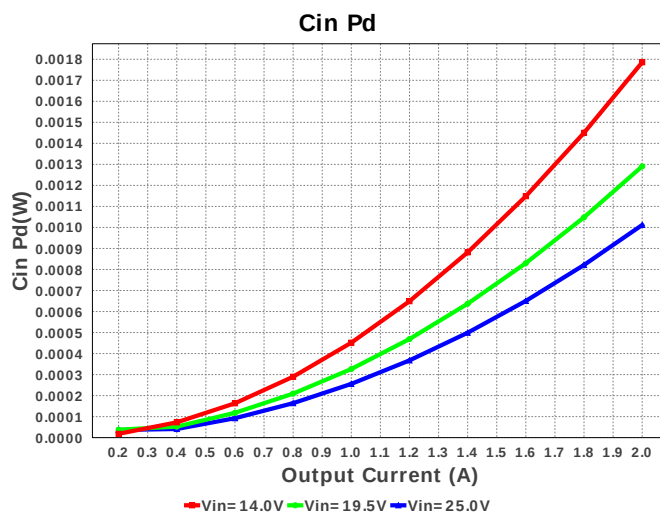
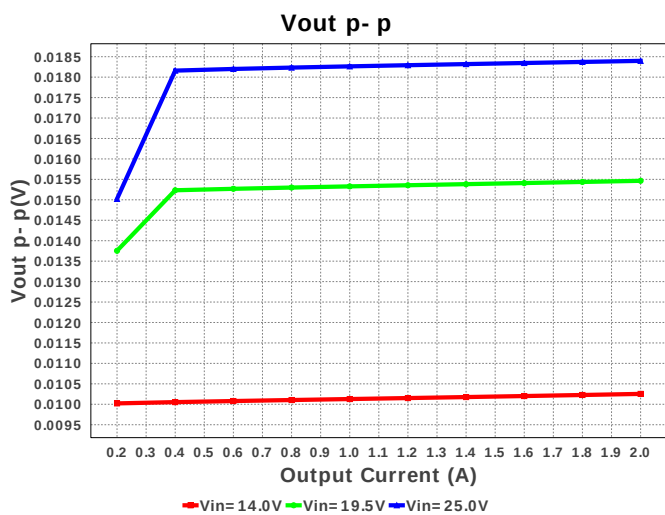
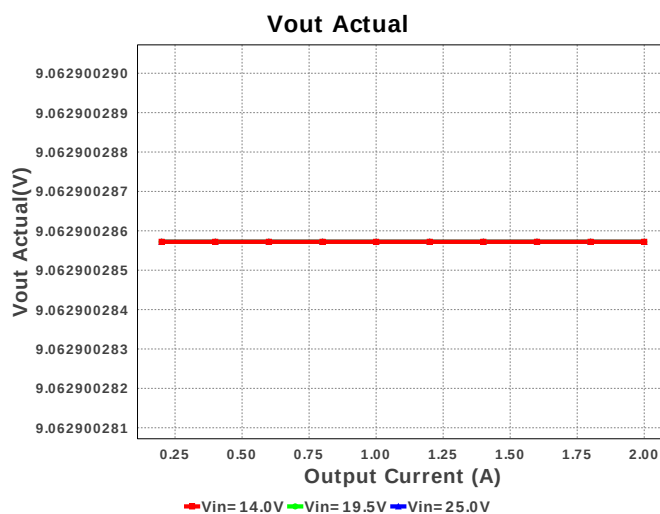
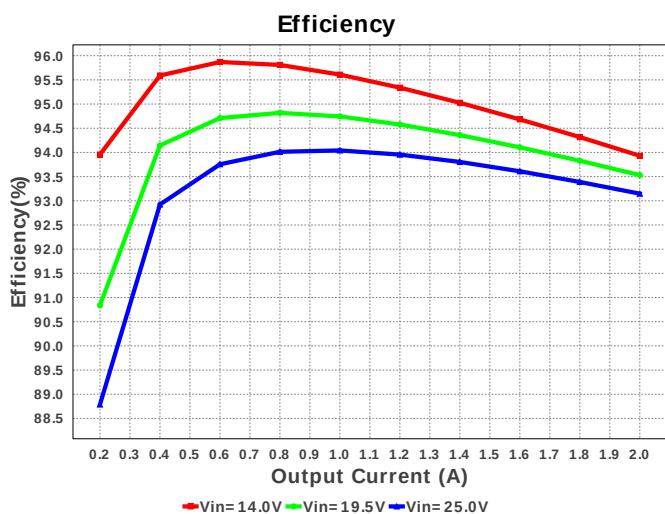
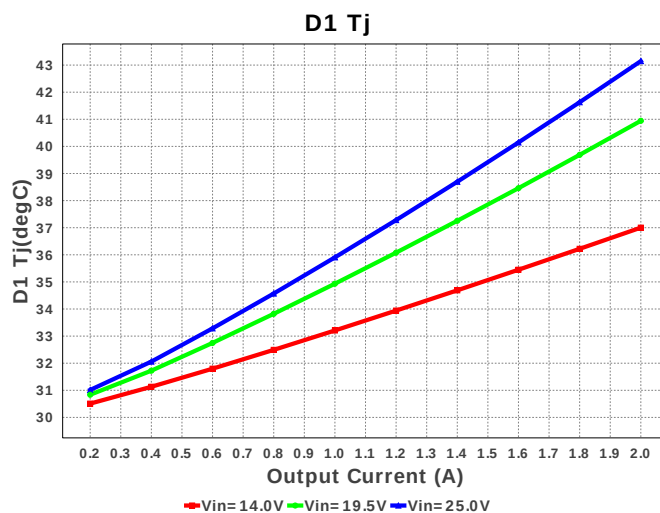
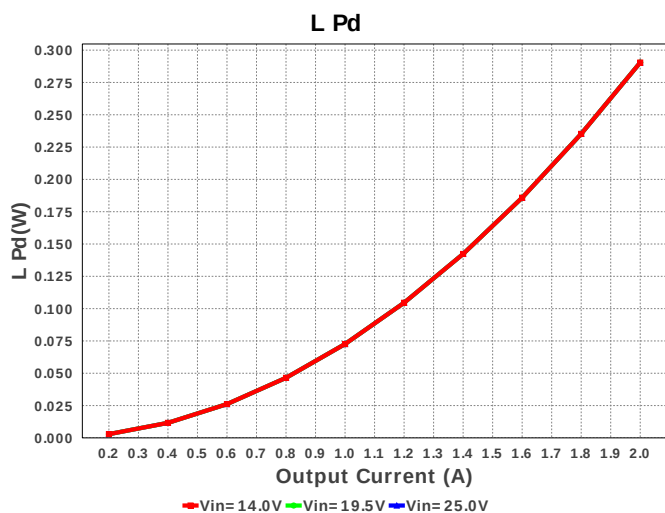


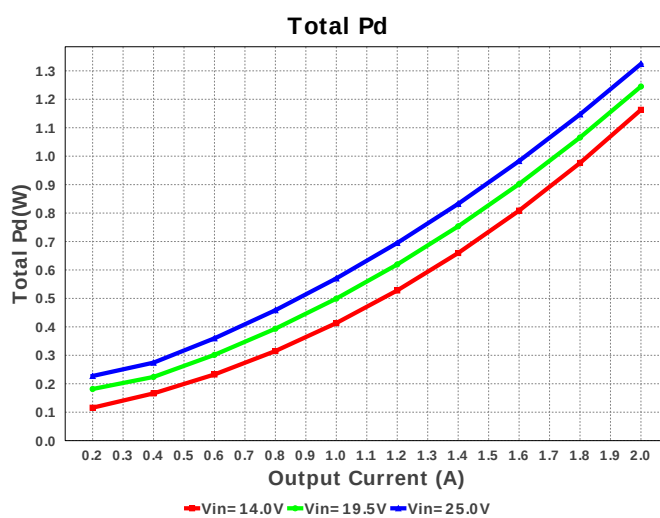
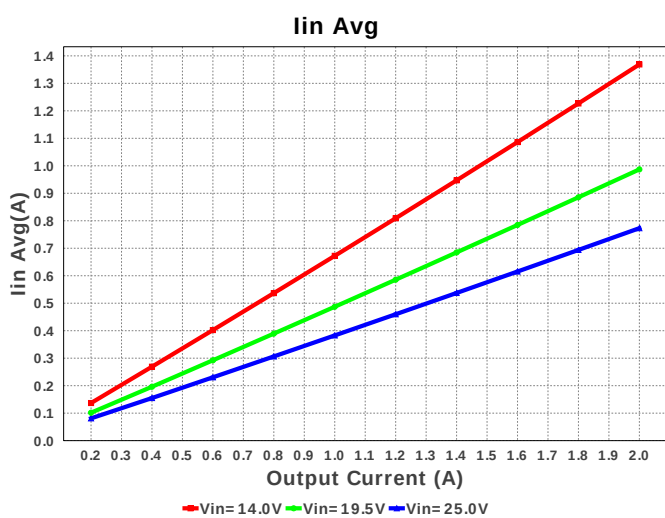
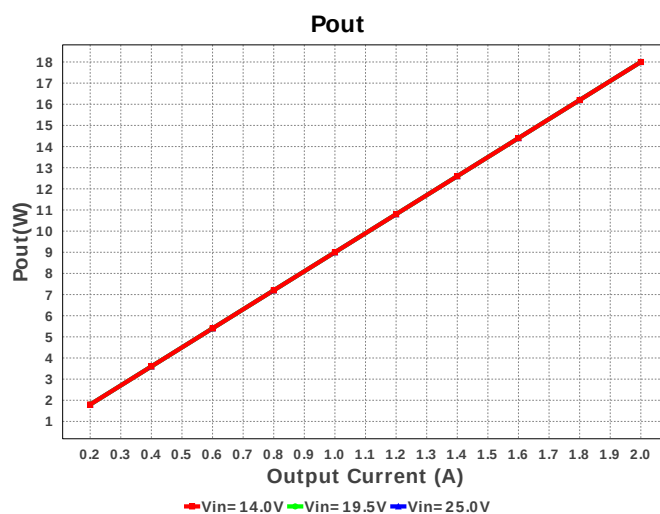
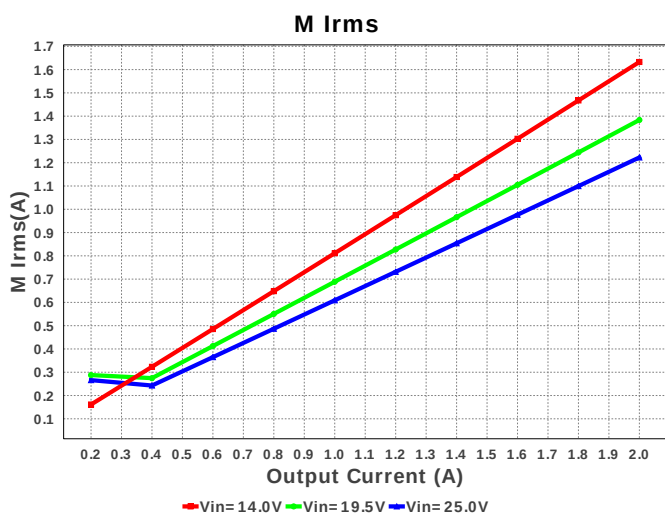
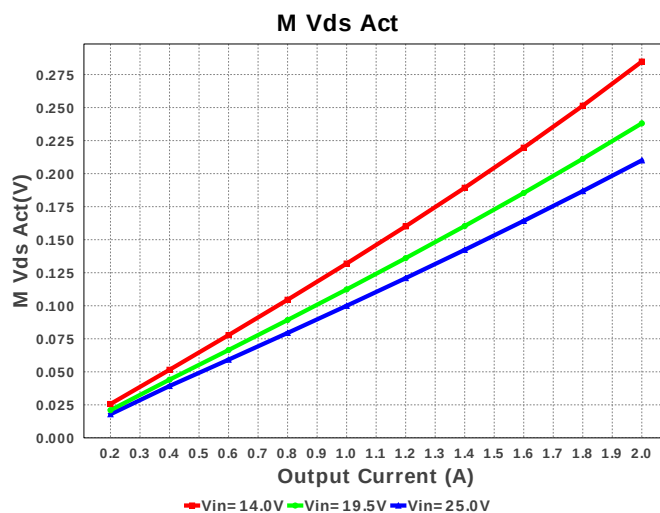
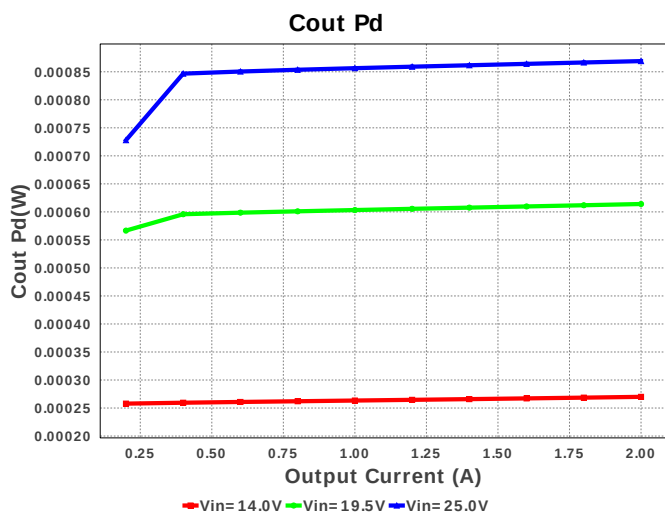


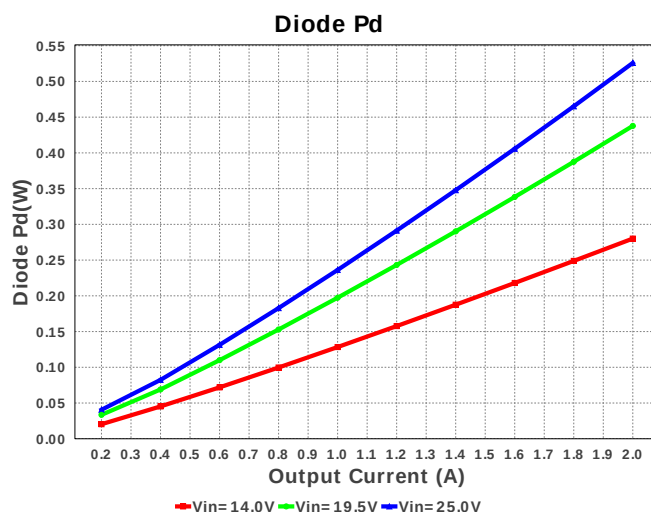
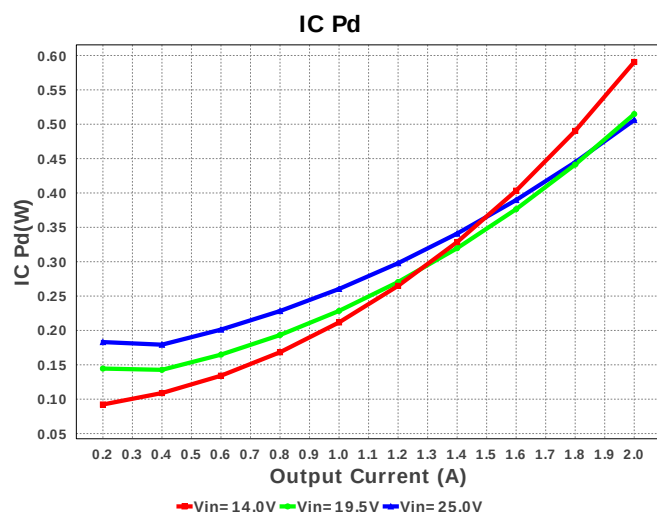
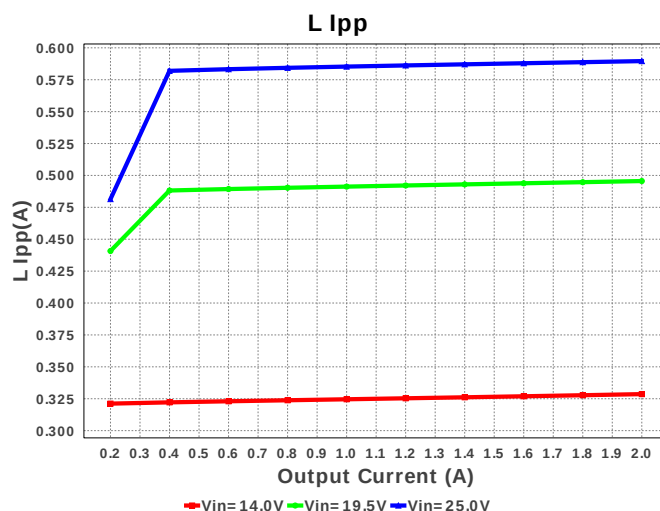
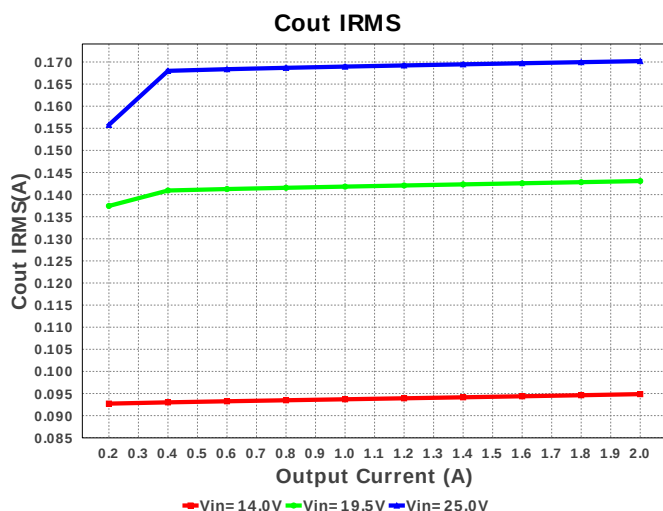
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Topology = Buck
Created = 7/15/16 6:35:04 PM
BOM Cost = \$2.99
BOM Count = 9
Total Pd = 1.32W

#	Name	Manufacturer	Part Number	Properties	Qty	Price	Footprint
7.	Rfb1	Panasonic	ERJ-6ENF1001V Series= ERJ-6E	Res= 1000.0 Ohm Power= 125.0 mW Tolerance= 1.0%	1	\$0.01	 0805 7 mm ²
8.	Rfb2	Panasonic	ERJ-6ENF6491V Series= ERJ-6E	Res= 6.49 kOhm Power= 125.0 mW Tolerance= 1.0%	1	\$0.01	 0805 7 mm ²
9.	U1	Texas Instruments	LM2670SX-ADJ/NOPB	Switcher	1	\$1.85	 TS7B 199 mm ²









Operating Values

#	Name	Value	Category	Description
1.	Cin IRMS	709.806 mA	Current	Input capacitor RMS ripple current
2.	Cout IRMS	170.202 mA	Current	Output capacitor RMS ripple current
3.	IC Ipk	2.295 A	Current	Peak switch current in IC
4.	Iin Avg	772.97 mA	Current	Average input current
5.	L Ipp	589.6 mA	Current	Peak-to-peak inductor ripple current
6.	M1 Irms	1.223 A	Current	Q lavg
7.	BOM Count	9	General	Total Design BOM count
8.	FootPrint	527.0 mm ²	General	Total Foot Print Area of BOM components
9.	Frequency	260.0 kHz	General	Switching frequency
10.	IC Tolerance	24.0 mV	General	IC Feedback Tolerance
11.	M Vds Act	210.022 mV	General	Voltage drop across the MosFET
12.	Pout	18.0 W	General	Total output power
13.	Total BOM	\$2.99	General	Total BOM Cost
14.	D1 Tj	43.147 degC	Op_Point	D1 junction temperature
15.	Vout Actual	9.063 V	Op_Point	Vout Actual calculated based on selected voltage divider resistors
16.	Vout OP	9.0 V	Op_Point	Operational Output Voltage
17.	Cross Freq	22.197 kHz	Op_point	Bode plot crossover frequency
18.	Duty Cycle	37.366 %	Op_point	Duty cycle
19.	Efficiency	93.147 %	Op_point	Steady state efficiency
20.	IC Tj	43.158 degC	Op_point	IC junction temperature
21.	ICThetaJA	26.0 degC/W	Op_point	IC junction-to-ambient thermal resistance
22.	IOUT_OP	2.0 A	Op_point	Iout operating point
23.	Phase Marg	52.244 deg	Op_point	Bode Plot Phase Margin
24.	VIN_OP	25.0 V	Op_point	Vin operating point
25.	Vout p-p	18.398 mV	Op_point	Peak-to-peak output ripple voltage
26.	Cin Pd	1.012 mW	Power	Input capacitor power dissipation
27.	Cout Pd	869.06 μW	Power	Output capacitor power dissipation
28.	Diode Pd	525.887 mW	Power	Diode power dissipation
29.	IC Pd	506.094 mW	Power	IC power dissipation
30.	L Pd	290.4 mW	Power	Inductor power dissipation
31.	Total Pd	1.324 W	Power	Total Power Dissipation

#	Name	Value	Category	Description
32.	Vout Tolerance	3.769 %		Vout Tolerance based on IC Tolerance (no load) and voltage divider resistors if applicable

Design Inputs

#	Name	Value	Description
1.	Iout	2.0	Maximum Output Current
2.	VinMax	25.0	Maximum input voltage
3.	VinMin	14.0	Minimum input voltage
4.	Vout	9.0	Output Voltage
5.	base_pn	LM2670	Base Product Number
6.	source	DC	Input Source Type
7.	Ta	30.0	Ambient temperature

Design Assistance

1. **LM2670** Product Folder : <http://www.ti.com/product/LM2670> : contains the data sheet and other resources.

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